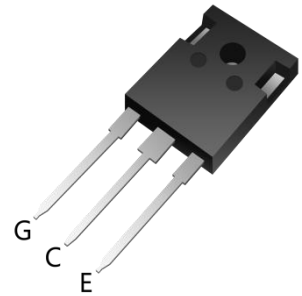
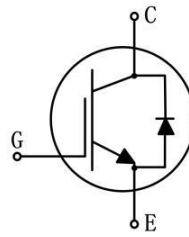


Trench Field-stop IGBT Discrete

Parameter	Value	Unit
V_{CE}	1200	V
I_C	25	A
$V_{CE(sat)}$	1.7	V



TO-247-3L

Features

- Trench and field-stop technology
- Low collector to emitter saturation voltage
- Easy parallel switching capability
- Short circuit withstands time 7μs
- High ruggedness performance
- RoHS compliant

Applications

- Inverters
- Motor drives

Maximum Ratings

Parameter	Symbol	Value	Unit
Collector-emitter voltage	V_{CES}	1200	V
Gate-emitter voltage	V_{GES}	±20	V
Continuous collector current($T_C=25^{\circ}C$)	I_C	50	A
Continuous collector current($T_C=100^{\circ}C$)		25	A
Pulsed collector current, tp limited by T_{vjmax}	I_{CM}	100	A
Diode continuous forward current($T_C=100^{\circ}C$)	I_F	25	A
Diode maximum current, tp limited by T_{vjmax}	I_{FM}	100	A
Short circuit withstand time	t_{sc}	10	μs
Power dissipation($T_C=25^{\circ}C$)	P_{tot}	428	W
Power dissipation($T_C=100^{\circ}C$)		214	
Operating junction temperature range	T_{vj}	-40 to+175	°C
Storage temperature range	T_{stg}	-55 to+150	°C

Thermal Characteristics

Parameter	Symbol	Value	Unit
Thermal resistance, junction to case for IGBT	$R_{th(j-c)}$	0.35	°C/W
Thermal resistance, junction to case for Diode	$R_{th(j-c)}$	0.9	°C/W
Thermal resistance, junction to ambient	$R_{th(j-a)}$	40	°C/W

Electrical Characteristics of IGBT ($T_{vj}=25^{\circ}\text{C}$ unless otherwise specified)
Static characteristics

Parameter	Symbol	Test condition	Value			Unit
			Min.	Typ.	Max.	
Collector-emitter breakdown voltage	$B_{V_{CES}}$	$V_{GE}=0V, I_C=250\mu A$	1200	-	-	V
Collector-emitter leakage current	I_{CES}	$V_{CE}=1200V, V_{GE}=0V$	-	-	100	μA
Gate leakage current, forward	I_{GES}	$V_{GE}=\pm 20V, V_{CE}=0V$	-	-	± 100	nA
Gate-emitter threshold voltage	$V_{GE(th)}$	$V_{GE}=V_{CE}, I_C=1mA (T_J=25^{\circ}\text{C})$	5.8	6.1	6.3	V
Collector-emitter saturation voltage	$V_{CE(sat)}$	$V_{GE}=15V, I_C=25A (T_J=25^{\circ}\text{C})$	-	1.7	-	V
		$V_{GE}=15V, I_C=25A (T_J=175^{\circ}\text{C})$	-	2.3	-	V
Input capacitance	C_{ies}	$V_{CE}=30V$	-	2081	-	nF
Output capacitance	C_{oes}	$V_{GE}=0V$	-	107	-	pF
Reverse transfer capacitance	C_{res}	$f=1\text{MHz}$	-	21	-	pF
Total gate charge	Q_g	$V_{CC}=960V V_{GE}=15V I_C=25A$	-	135	-	nC

Switching Characteristics

Parameter	Symbol	Test condition	Value			Unit
			Min.	Typ.	Max.	
Turn-on delay time	$t_{d(on)}$	$V_{CC}=600V$ $V_{GE}=15V$ $I_C=25A$ $R_G=10\Omega$ Inductive load	-	33	-	ns
Rise time	t_r		-	63	-	ns
Turn-off delay time	$t_{d(off)}$		-	185	-	ns
Fall time	t_f		-	61	-	ns
Turn-on energy	E_{on}		-	2.1	-	mJ
Turn-off energy	E_{off}		-	1.1	-	mJ
Total switching energy	E_{ts}		-	3.1	-	mJ
Turn-on delay time	$t_{d(on)}$	$V_{CC}=600V$ $V_{GE}=15V$ $I_C=25A$ $R_G=10\Omega$ Inductive load $T_{vj}=175^{\circ}\text{C}$	-	35	-	ns
Rise time	t_r		-	69	-	ns
Turn-off delay time	$t_{d(off)}$		-	207	-	ns
Fall time	t_f		-	89	-	ns
Turn-on energy	E_{on}		-	3.3	-	mJ
Turn-off energy	E_{off}		-	1.5	-	mJ
Total switching energy	E_{ts}		-	4.5	-	mJ

Diode Characteristics

Parameter	Symbol	Test condition	Values			Unit
			Min.	Typ.	Max.	
Diode forward voltage	V_F	$I_F=25A, T_{vj}=25^\circ C$	-	2.0	-	V
		$I_F=25A, T_{vj}=175^\circ C$	-	1.6	-	V
Diode reverse recovery time	t_{rr}	$V_R=600V$	-	311	-	ns
Diode peak reverse recovery current	I_{rrm}	$I_F=25A$	-	7.1	-	A
Diode reverse recovery charge	Q_{rr}	$diF/dt=-250A/\mu s$	-	1039	-	nC
Diode reverse recovery time	t_{rr}	$V_R=600V$	-	482	-	ns
Diode peak reverse recovery current	I_{rrm}	$I_F=25A$	-	11.1	-	A
Diode reverse recovery charge	Q_{rr}	$diF/dt=-250A/\mu s, T_{vj}=175^\circ C$	-	3001	-	nC

Typical Characteristics

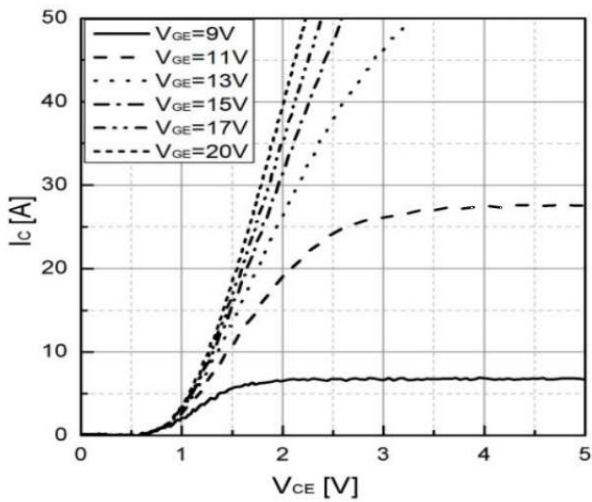


Figure 1. Typical output characteristic ($T_{vj}=25^\circ C$)

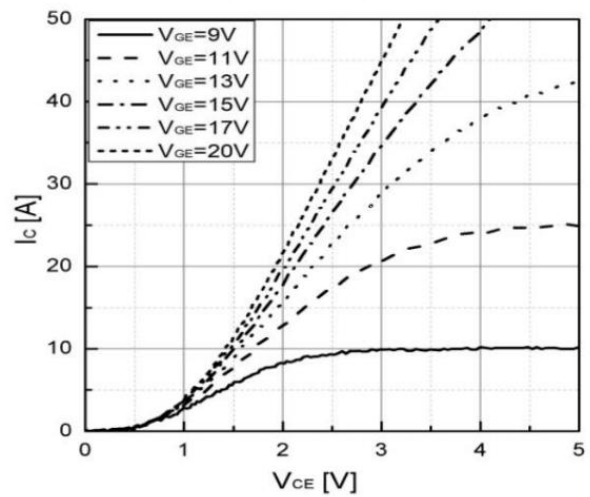


Figure 2. Typical output characteristic ($T_{vj}=175^\circ C$)

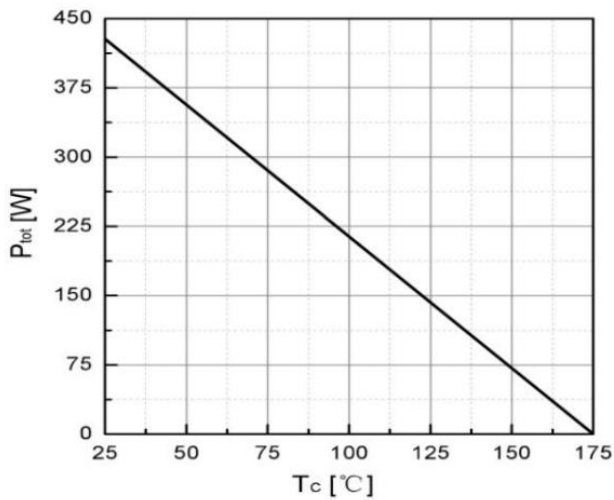


Figure 3. Power dissipation as a function of T_c

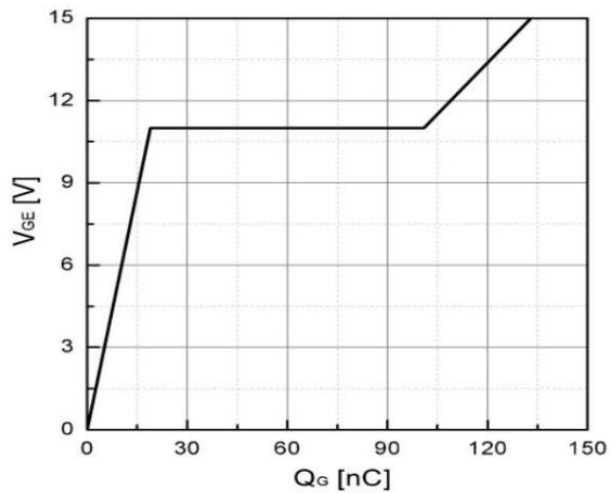


Figure 4. Typical Gate charge

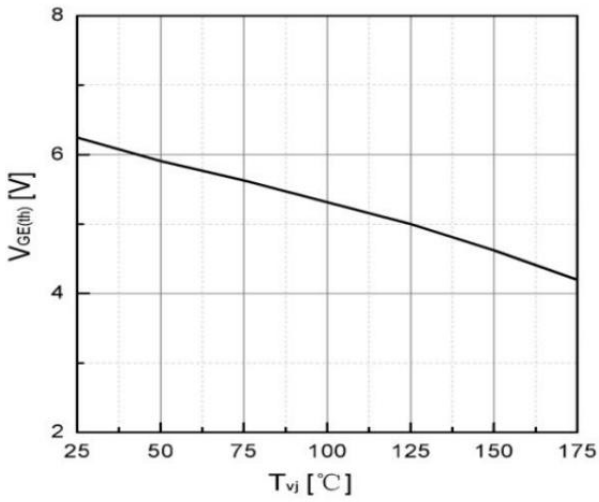


Figure 5. Typical $V_{GE(th)}$ as a function of T_{vj} ($I_C=1mA$)

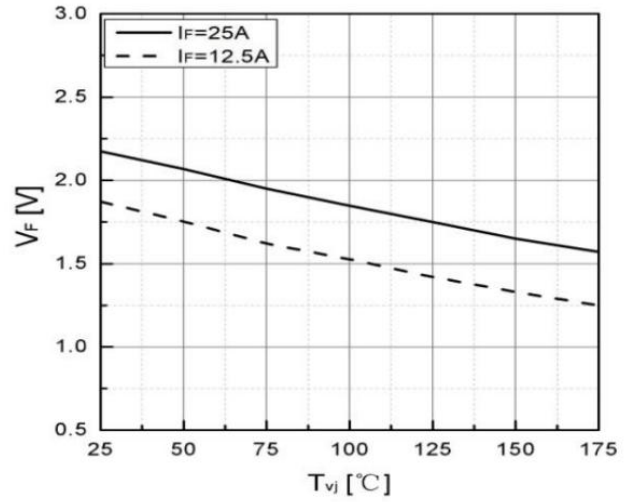


Figure 6. Typical V_F as a function of T_{vj}

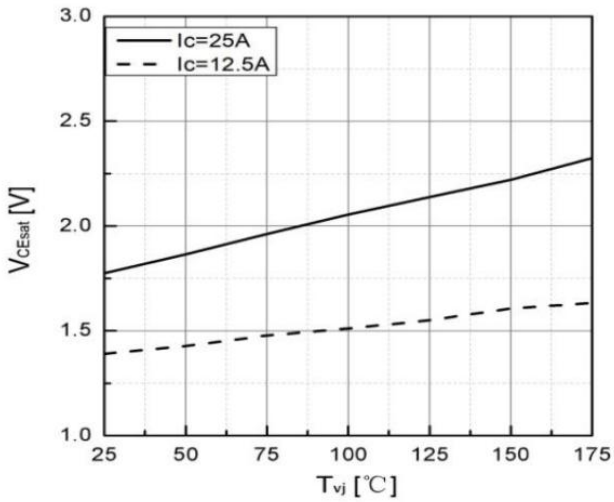


Figure 7. Typical $V_{CE(sat)}$ as a function of T_{vj}

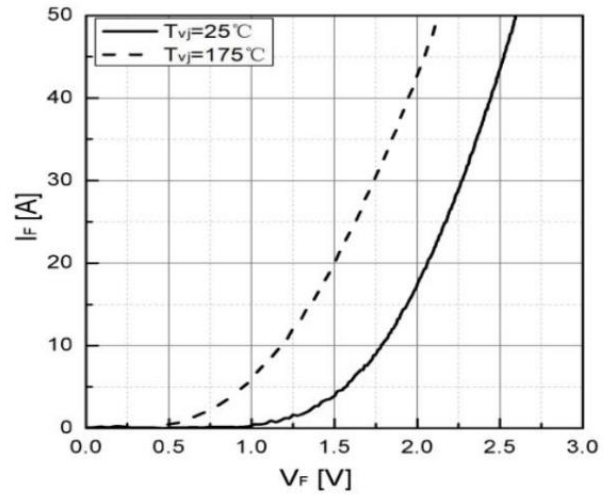


Figure 8. Typical I_F as a function of V_F

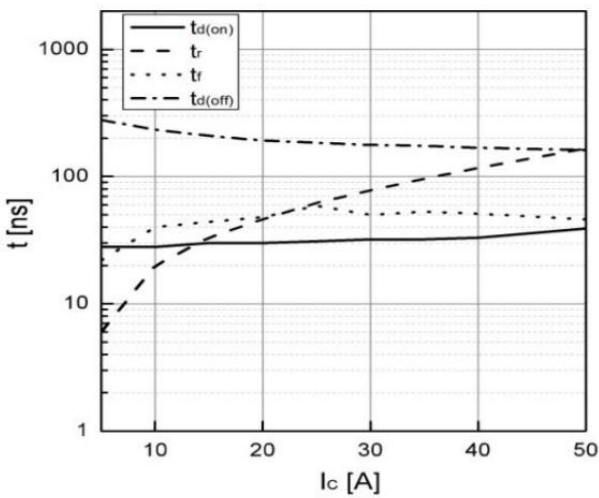


Figure 9. Typical switching time as a function of I_C

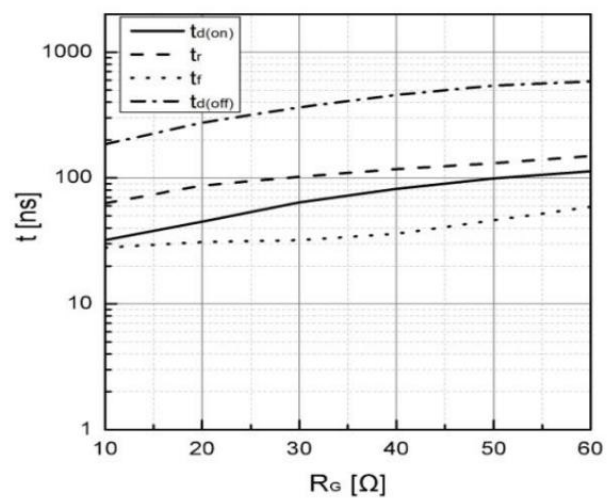


Figure 10. Typical switching times as a function of R_G

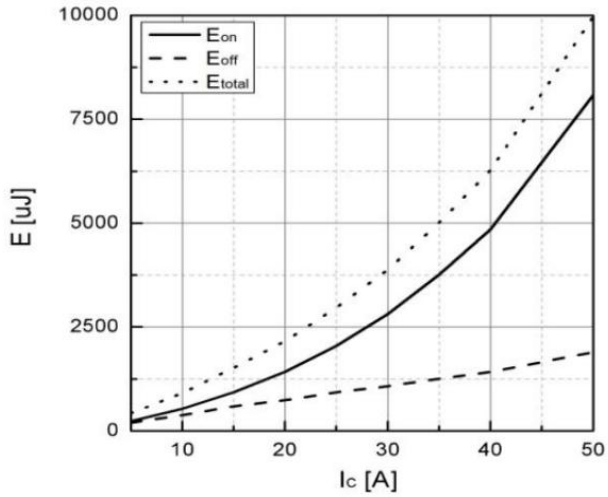


Figure 11. Typical switching energy losses as a function of I_c

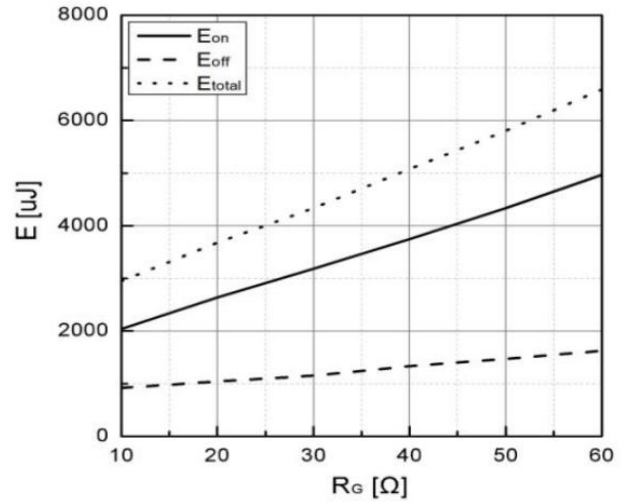


Figure 12. Typical switching energy losses as a function of R_G

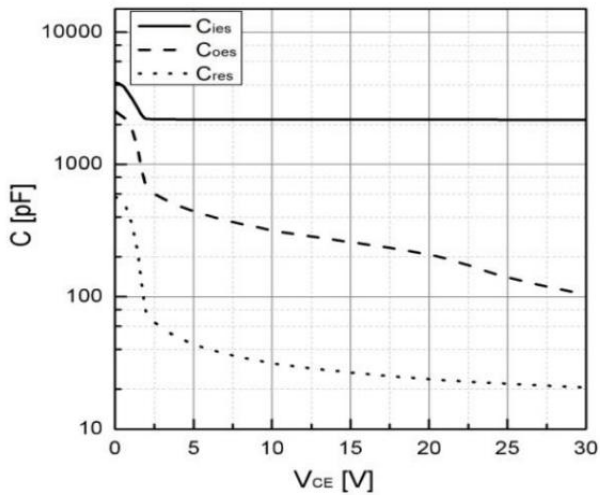


Figure 13. Typical capacitance as a function of V_{CE} ($f=1\text{MHz}, V_{GE}=0\text{V}$)

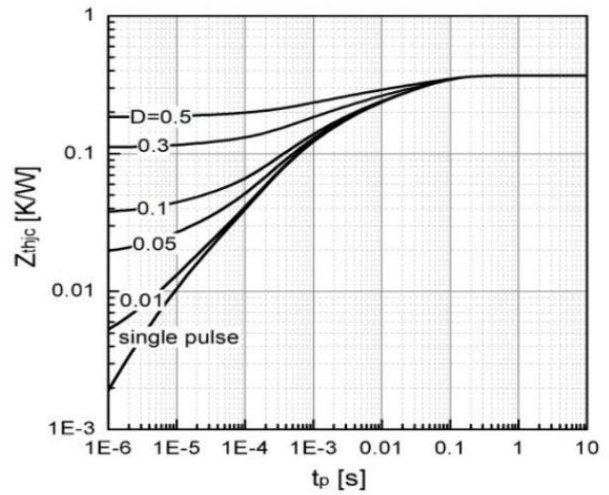
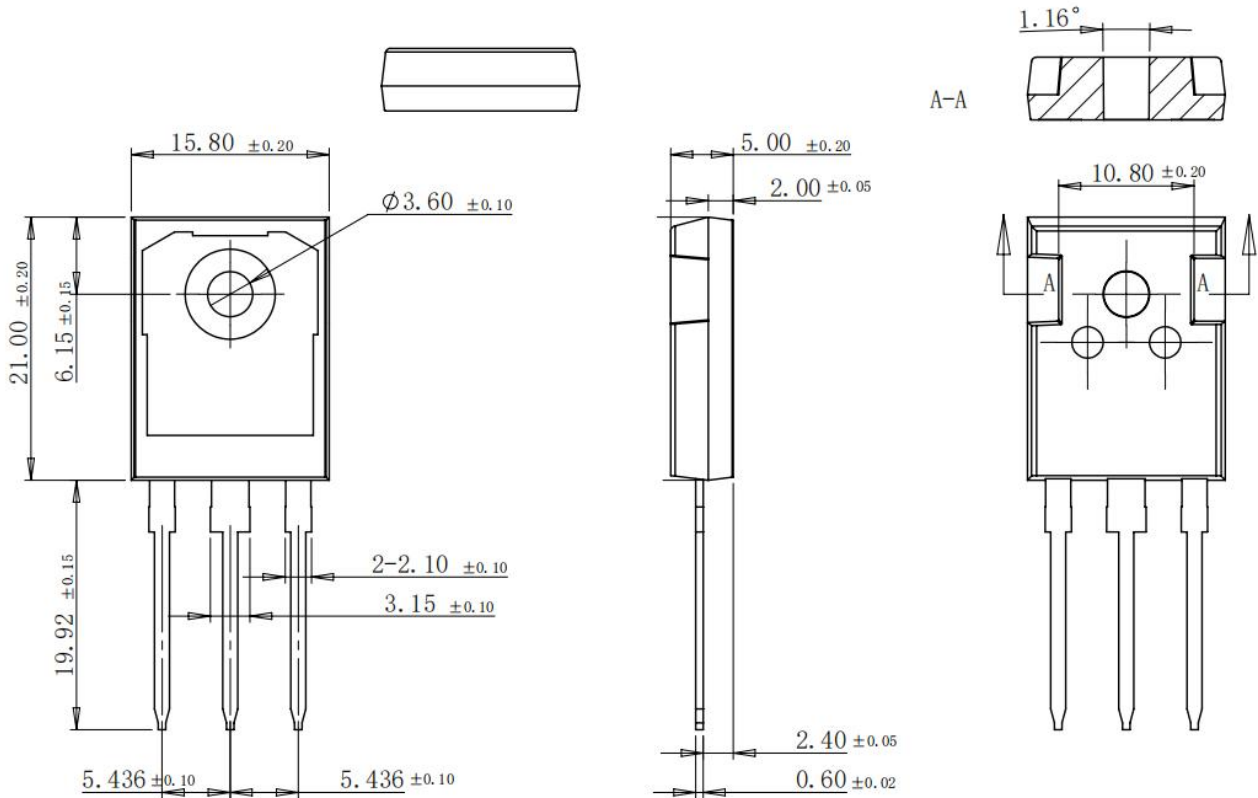


Figure 14. Transient thermal impedance of IGBT

Package Outlines (Unit: mm)

TO-247-3L



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